

### **General Description**

The MAX8934G dual-input Li+/Li-Poly linear battery charger with Smart Power Selector™ safely charges a single Li+/Li-Poly cell in accordance with JEITA\* recommendations. The MAX8934G monitors the battery temperature (TBATT) while charging, and automatically adjusts the fast-charge current and charge termination voltage as the battery temperature varies. The MAX8934G also monitors the battery temperature while the battery is discharging, and provides a warning flag (OT) to the system in the event that the battery is over temperature. Safety region 2 is supported (see Figure 6 for details). An ultra-low IQ. always-on LDO provides an additional 3.3V supply for system power.

The MAX8934G operates with either separate inputs for USB and AC adapter power, or from a single input that accepts both. All power switches for charging and switching the load between battery and external power are included on-chip. No external MOSFETs are required.

The MAX8934G features a Smart Power Selector to make the best use of limited USB or adapter power. Input current limit and battery charge current limit are independently set. Input power not used by the system charges the battery. Charge current limit and DC current limit can be set up to 1.5A and 2A, respectively, while USB input current can be set to 100mA or 500mA. Automatic input selection switches the system load from battery to external power.

The MAX8934G provides a SYS output voltage of 4.35V.

Other features include overvoltage protection (OVP), open-drain charge status and fault outputs, power-OK monitors, charge timers, and a battery thermistor monitor. Additionally, on-chip thermal limiting reduces the battery charge-rate to prevent charger overheating. The MAX8934G is available in a 28-pin, 4mm x 4mm, TQFN package.

#### **Applications**

PDAs, Palmtop, and Wireless Handhelds Portable Media, MP3 Players, and PNDs Digital Still Cameras and Digital Video Cameras Handheld Game Systems

\*JEITA (Japan Electronics and Information Technology Industries Association) Standard, A Guide to the Safe Use of Secondary Lithium Ion Batteries on Notebook-Type Personal Computers, April 20, 2007.

Smart Power Selector is a trademark of Maxim Integrated Products, Inc.

#### **Features**

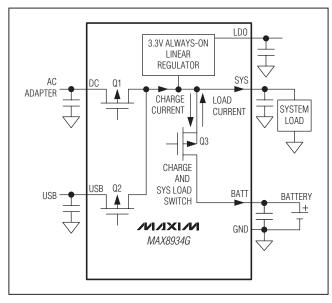
- ♦ Li+ Charger with Smart Power Selector, No External MOSFETs Needed
- ♦ Monitors Battery Temperature and Adjusts Charge **Current and Termination Voltage Automatically** per JEITA Recommendations
- ♦ OT Flags System of a Hot Battery During **Discharge**
- ♦ Ultra-Low IQ, Always-On 3.3V LDO
- ♦ Common or Separate USB and Adapter Inputs
- ♦ Automatic Adapter/USB/Battery Switchover
- ♦ Load Peaks in Excess of Adapter Rating are Supported by Battery
- ♦ Input OVP to 16V (DC) and 9V (USB)
- ♦ 40mΩ SYS-to-BATT Switch
- ♦ Thermal Regulation Prevents Overheating
- ♦ 4.35V SYS Regulation Voltage

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX8934GETI+	-40°C to +85°C	28 Thin QFN-EP**

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

### **Typical Operating Circuit**



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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

<sup>\*\*</sup>EP = Exposed pad.

#### **ABSOLUTE MAXIMUM RATINGS**

BATT Continuous Current (total in two pins) LDO Continuous Current LDO Short-Circuit Duration Continuous Power Dissipation (TA = +70°C	50mARMS Continuous
Single-Layer Board (derate 20.8mW/°C above +70°C) Multilayer Board	1666.7mW
(derate 28.6mW/°C above +70°C)  Operating Temperature Range  Junction Temperature  Storage Temperature (soldering, 10s)  Lead Temperature (reflow)	-40°C to +85°C -40°C to +125°C 

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(VDC = VPEN1 = VPEN2 = 5V,  $\overline{\text{CEN}}$  = USUS = THMEN = GND, VBATT = 4V, VTHM = 1.65V, USB, THMSW,  $\overline{\text{CHG}}$ ,  $\overline{\text{DONE}}$ ,  $\overline{\text{OT}}$ ,  $\overline{\text{DOK}}$ ,  $\overline{\text{UOK}}$ ,  $\overline{\text{FLT}}$  are unconnected, CCT = 0.068µF, TA = -40°C to +85°C, unless otherwise noted. Typical values are at TA = +25°C.) (Note 1)

PARAMETER	CC	MIN	TYP	MAX	UNITS	
DC-to-SYS PREREGULATOR						
DC Operating Voltage Range						V
DC Withstand Voltage	VBATT = VSYS = 0V				14	V
DC Undervoltage Threshold	When VDOK goes low,	VDC rising, 500mV hysteresis	3.95	4.0	4.05	V
DC Overvoltage Threshold	When VDOK goes high,	V <sub>DC</sub> rising, 360mV hysteresis	6.8	6.9	7.0	V
DC Operating Supply Current	ISYS = IBATT = 0mA, Vo	<del>EEN</del> = 0V		1	2	mA
DC Operating Supply Current	ISYS = IBATT = 0mA, Vo	<del>EN</del> = 5V		0.8	1.5	MA
DC Suspend Current	VDC = VCEN = Vusus =	5V, V <sub>PEN1</sub> = 0V		195	340	μΑ
DC-to-SYS On-Resistance	Isys = 400mA, VCEN =	5V		0.2	0.35	Ω
DC to BATT Dropout Voltage	When SYS regulation ar 150mV hysteresis	When SYS regulation and charging stops, VDC falling, 150mV hysteresis				mV
		RPSET = $1.5$ k $\Omega$	1800	2000	2200	
	V <sub>DC</sub> = 5V, V <sub>SYS</sub> = 4V, T <sub>A</sub> = +25°C	RPSET = $3k\Omega$	900	1000	1100	
		RPSET = $6.3k\Omega$	450	475	500	
DC Current Limit		VPEN1 = 0V, VPEN2 = 5V (500mA USB mode)	450	475	500	
		VPEN1 = VPEN2 = 0V (100mA USB mode)	80	95	100	
PSET Resistance Range			1.5		6.3	kΩ
SYS Regulation Voltage	VDC = 6V, ISYS = 1mA t	o 1.75A, V <del>CEN</del> = 5V	4.29	4.35	4.4	V
Input Current Soft-Start Time	Connecting DC with USB not present			1.5		ms
Imput Current Soit-Start Time	Connecting DC with US	B present		50		μs
Thermal-Limit Temperature	Die temperature at when the charging current and input current limits are reduced			100		°C
Thermal-Limit Gain	Isys reduction with die	temperature (above +100°C)		5		%/C
V <sub>L</sub> Voltage	$I_{VL} = 0$ to 5mA, USB = $\iota$	unconnected	3	3.3	3.6	V

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### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DC} = V_{PEN1} = V_{PEN2} = 5V, \overline{CEN} = USUS = THMEN = GND, V_{BATT} = 4V, V_{THM} = 1.65V, USB, THMSW, \overline{CHG}, \overline{DONE}, \overline{OT}, \overline{DOK}, \overline{UOK}, \overline{FLT}$  are unconnected,  $C_{CT} = 0.068\mu F$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 1)

	CONDITIONS	MIN	TYP	MAX	UNITS	
		4.1		6.6	V	
VBATT = VSYS = 0V				8	V	
When VUOK goes lov	w, V <sub>USB</sub> rising, 500mV hysteresis	3.95	4.0	4.05	V	
When VUOK goes high	gh, V <sub>USB</sub> rising, 360mV hysteresis	6.8	6.9	7.0	V	
ISYS = IBATT = 0mA,	VCEN = VPEN2 = 0V		1	2	m A	
ISYS = IBATT = 0mA,	$V\overline{CEN} = 5V$ , $VPEN2 = 0V$		0.9	1.5	mA mA	
DC = unconnected, '	Vusb = V <del>cen</del> = Vusus = 5V		190	340	μΑ	
DC unconnected, Vu	$JSB = V\overline{CEN} = 5V$ , $ISYS = 400mA$		0.22	0.33	Ω	
When SYS regulation 150mV hysteresis	and charging stops, V <sub>USB</sub> falling,	10	50	90	mV	
DC unconnected,	VPEN1 = 0V, VPEN2 = 5V	450	475	500		
VUSB = 5V, TA = +25	5°C VPEN1 = VPEN2 = 0V	80	95	100	mA mA	
		4.29	4.35	4.4	V	
Input current ramp til	me		50		μs	
·		100		°C		
ISYS reduction with d	lie temperature (above +100°C)		5		%/°C	
	3	3.3	3.6	V		
'						
DC unconnected, VusB = 5V, ILDO = 0mA			3.3	3.366	V	
V <sub>DC</sub> = 5V, USB unconnected, I <sub>LDO</sub> = 0mA			3.3	3.366		
			3.3	3.366		
$I_{LDO} = 0$ to $30mA$			0.003		%/mA	
		,				
V <sub>DC</sub> = 0V, V <sub>BATT</sub> = 4	1.2V, ISYS = 1A		0.04	0.08	Ω	
VPEN1 = VPEN2 = 0V	, ISYS = 200mA	50	75	105	mV	
	TA = +25°C, VTHM_T2 < VTHM < VTHM_T3	4.175	4.2	4.225		
	TA = 0°C to +85°C, VTHM_T2 < VTHM < VTHM_T3	4.158	4.2	4.242		
IBATT = 0mA	TA = +25°C, VTHM_T1 < VTHM < VTHM_T2 or VTHM_T3 < VTHM < VTHM_T4	4.05	4.075	4.1	V	
	TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T2 or VTHM_T3 < VTHM < VTHM_T4	4.034	4.075	4.1		
	When VUOK goes low When VUOK goes low When VUOK goes his ISYS = IBATT = 0mA, ISYS = IBATT = 0mA, DC = unconnected, VL When SYS regulation 150mV hysteresis DC unconnected, VUSB = 5V, TA = +25 DC unconnected, VL to 400mA, VCEN = 5 Input current ramp ti Die temperature at w current limits are red ISYS reduction with co DC unconnected, VL VDC = 5V, USB unco DC and USB unconnected, VL VDC = 0V, VBATT = 4 VPEN1 = VPEN2 = 0V	VBATT = VSYS = 0V  When VUOK goes low, VUSB rising, 500mV hysteresis  When VUOK goes high, VUSB rising, 360mV hysteresis  ISYS = IBATT = 0mA, VCEN = VPEN2 = 0V  ISYS = IBATT = 0mA, VCEN = 5V, VPEN2 = 0V  DC = unconnected, VUSB = VCEN = 5V, ISYS = 400mA  When SYS regulation and charging stops, VUSB falling, 150mV hysteresis  DC unconnected, VUSB = 5V, TA = +25°C  DC unconnected, VUSB = 6V, VPEN2 = 5V, ISYS = 1mA to 400mA, VCEN = 5V  Input current ramp time  Die temperature at when the charging current and input current limits are reduced  ISYS reduction with die temperature (above +100°C)  DC unconnected, VUSB = 5V, ILDO = 0mA  VDC = 5V, USB unconnected, ILDO = 0mA  DC and USB unconnected, VBATT = 4V, ILDO = 0mA  ILDO = 0 to 30mA  VDC = 0V, VBATT = 4.2V, ISYS = 1A  VPEN1 = VPEN2 = 0V, ISYS = 200mA  IBATT = 0mA  IBATT = 0mA  IBATT = 0mA  IBATT = 0mA  VTHM_T3  TA = +25°C, VTHM_T2 < VTHM < VTHM_T3  TA = +25°C, VTHM_T1 < VTHM < VTHM_T3  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T1 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM < VTHM_T4  TA = 0°C to +85°C, VTHM_T3 < VTHM_T4	VBATT = VSYS = 0V	VBATT = VSYS = 0V	VBATT = VSYS = 0V	

### **ELECTRICAL CHARACTERISTICS (continued)**

PARAMETER	CONDITIONS			TYP	MAX	UNITS	
DATED	Change in VBATT	VTHM_T2 < VTHM < VTHM_T3	-145	-104	-65		
BATT Recharge Threshold— Safety Region 2	from DONE to fast- charge restart	VTHM_T1 < VTHM < VTHM_T2 or VTHM_T3 < VTHM < VTHM_T4	-120	-80	-40	mV	
BATT Fast-Charge Current Range	RISET = $10k\Omega$ to $2k\Omega$		0.3		1.5	А	
		RISET = $2k\Omega$	1350	1500	1650		
		$RISET = 4k\Omega$	675	750	825	1	
		RISET = $10k\Omega$	270	300	330		
BATT Charge Current Accuracy	VSYS = 5.5V, VTHM_T1 < VTHM < VTHM T4 (safety	$R_{ISET} = 2k\Omega$ , $V_{BATT} = 2.5V$ (prequal)	270	300	330	mA	
	region 2)	$R_{ISET} = 4k\Omega$ , $V_{BATT} = 2.5V$ (prequal)	130	150	170		
		$R_{ISET} = 10k\Omega$ , $V_{BATT} = 2.5V$ (prequal)		60			
ISET Output Voltage	RISET = 4kΩ, IBATT = charge current) V <sub>THM</sub>	0.9	1	1.1	V		
Charger Soft-Start Time	Charge-current ramp		1.5		ms		
BATT Prequal Threshold	VBATT rising, 180mV	nysteresis	2.9	3	3.1	V	
		No DC or USB power connected, THMEN = low, VCEN = 5V		5	12		
BATT Input Current	VBATT = 4.2V, ILDO = 0	No DC or USB power connected, THMEN = high, VCEN = 5V		12	25	μΑ	
		DC or USB power connected, VCEN = 5V		0.003	2		
DONE Threshold as a Percentage of Fast-Charge Current	IBATT decreasing			20		%	
Maximum Prequal Time	From CEN falling to end of prequal charge, VBATT = 2.5V			180		min	
Maximum Fast-Charge Time	From CEN falling to FLT falling			300		min	
Maximum Top-Off Time		_		15		s	
Timer Accuracy			-20		+20	%	
Timer Extend Threshold	Percentage of fast-charge current below where the timer clock operates at half-speed			50		%	
Timer Suspend Threshold	Percentage of fast-ch clock pauses	arge current below where timer		20		%	

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### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{DC} = V_{PEN1} = V_{PEN2} = 5V, \overline{CEN} = USUS = THMEN = GND, V_{BATT} = 4V, V_{THM} = 1.65V, USB, THMSW, \overline{CHG}, \overline{DONE}, \overline{OT}, \overline{DOK}, \overline{UOK}, \overline{FLT}$  are unconnected,  $C_{CT} = 0.068\mu F$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 1)

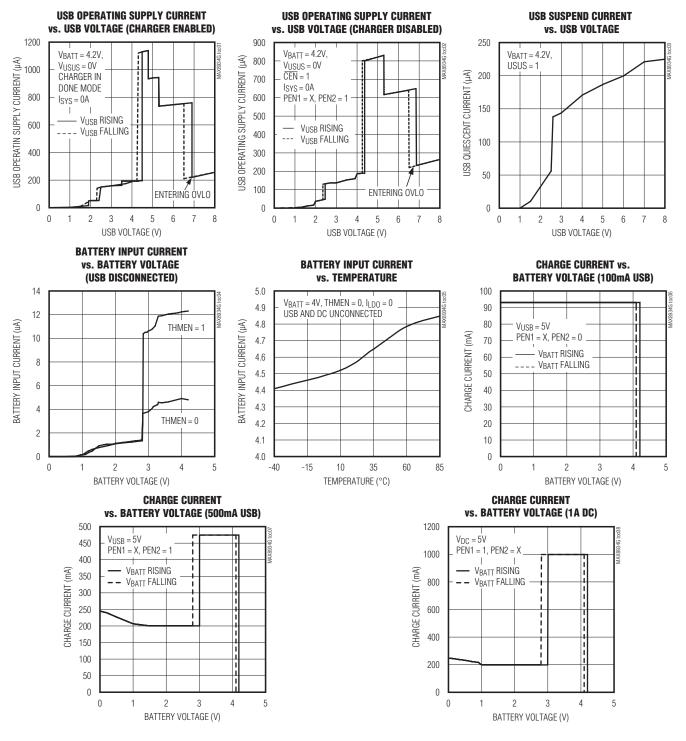
PARAMETER	C	MIN	TYP	MAX	UNITS		
THERMISTOR MONITOR (Beta :	= 3964) (Note 2)						
TIM Cold No Charge Threehold					+2.4	°C	
THM Cold No-Charge Threshold (T1)	ICHG = 0A, when charg	76.4	77.2	77.9	% of THMSW		
			8.2	10	12	°C	
THM Cold Threshold (T2)	VBATT_REG, reduced, 2	VBATT_REG, reduced, 2°C hysteresis				% of THMSW	
			42.8	45	47.5	°C	
THM Hot Threshold (T3)	VBATT_REG reduced, 2.	.5°C hysteresis	29.8	30	30.6	% of THMSW	
TI INA I I at NI a Clara una Thurada al al	1 O A		57	60	63.5	°C	
THM Hot No-Charge Threshold (T4)	hysteresis	rging is suspended, 3°C	19.5	19.8	20.1	% of THMSW	
T. M. J				75	80	°C	
THM Hot Discharge Threshold (ToT)	OT asserts low, 5°C hys	12.6	12.9	13.1	% of THMSW		
TUM Input leakage	THM = GND or LDO	T <sub>A</sub> = +25°C	-1	+0.001	+1		
THM Input leakage	THIN = GIND OF LDO	$T_A = +85^{\circ}C$		0.01		μΑ	
THMSW Output Leakage	THMSW = GND	TA = +25°C	-0.2	+0.001	+1	μΑ	
Triviovi Output Leakage	THIVIOVV = CIND	$T_A = +85^{\circ}C$		0.01			
THMSW Output Voltage High	Sourcing 1mA		V <sub>LDO</sub> - 0.05			V	
LOGIC I/O: PEN1, PEN2, CHG, F	$\overline{\text{LT}}, \overline{\text{DONE}}, \overline{\text{DOK}}, \overline{\text{UOK}}, \overline{\text{UOK}}$	USUS, THMEN)					
	High level		1.3			- V	
Logic-Input Thresholds	Low level				0.4	V	
	Hysteresis			50		mV	
Logic-Input Leakage Current	V <sub>IN</sub> = 0 to 5.5V	$T_A = +25^{\circ}C$		0.001	1	μA	
		T <sub>A</sub> = +85°C		0.01		μΛ	
Logic-Low Output Voltage	Sinking 1mA			25	100	mV	
Logic-High Output Leakage	V <sub>OUT</sub> = 5.5V	T <sub>A</sub> = +25°C		0.001	1	μA	
Current	1.001 0.01	$T_A = +85^{\circ}C$		0.01		μΑ	

Note 1: Limits are 100% production tested at  $T_A = +25$ °C. Limits over the operating temperature range are guaranteed by design.

**Note 2:** °C includes external NTC thermistor error. % of THMSW excludes thermistor beta error and external pullup error. NTC thermistor assumed to be  $100k\Omega \pm 1\%$  nominal, part number Vishay NTHS0603N01N1003FF, external pullup resistor =  $100k\Omega \pm 1\%$ .

### **Typical Operating Characteristics**

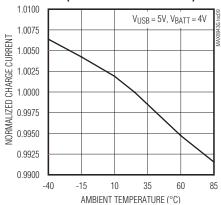
(T<sub>A</sub> = +25°C, circuit of Figure 2, V<sub>DC</sub> = 6V, V<sub>BATT</sub> = 3.6V, thermistor Beta = 3964, unless otherwise noted. Negative battery current indicates charging.)



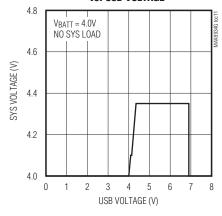
### **Typical Operating Characteristics (continued)**

 $(T_A = +25^{\circ}C, \text{ circuit of Figure 2}, V_{DC} = 6V, V_{BATT} = 3.6V, \text{ thermistor Beta} = 3964, \text{ unless otherwise noted}.$  Negative battery current indicates charging.)

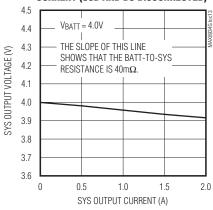
#### NORMALIZED CHARGE CURRENT vs. ambient temperature (Low IC Power Dissipation)



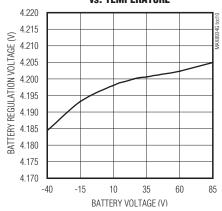
### SYS OUTPUT VOLTAGE vs. USB VOLTAGE



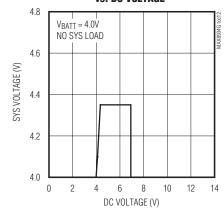
## SYS OUTPUT VOLTAGE vs. SYS OUTPUT CURRENT (USB AND DC DISCONNECTED)



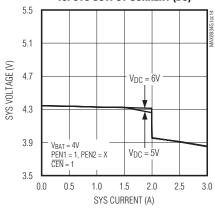
## BATTERY REGULATION VOLTAGE vs. Temperature



## SYS OUTPUT VOLTAGE vs. DC VOLTAGE

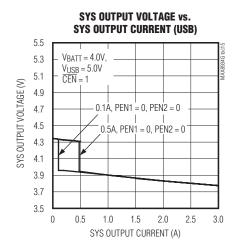


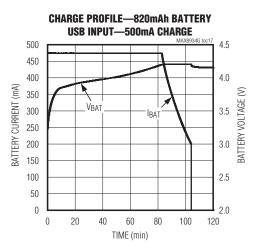
## SYS OUTPUT VOLTAGE vs. SYS OUTPUT CURRENT (DC)

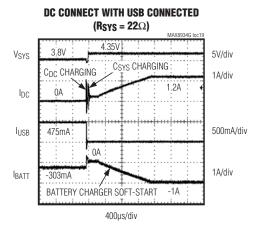


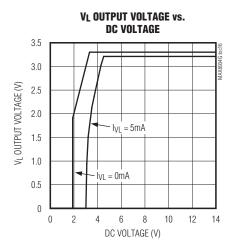
### Typical Operating Characteristics (continued)

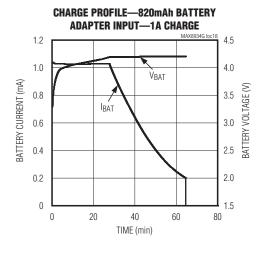
 $(T_A = +25^{\circ}C, circuit of Figure 2, V_{DC} = 6V, V_{BATT} = 3.6V, thermistor Beta = 3964, unless otherwise noted. Negative battery current indicates charging.)$ 

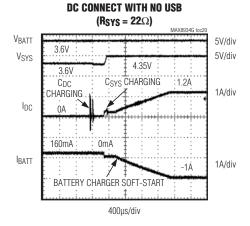










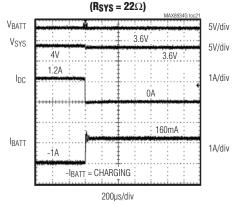


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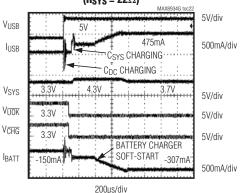
### Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, \text{ circuit of Figure 2}, V_{DC} = 6V, V_{BATT} = 3.6V, \text{ thermistor Beta} = 3964, \text{ unless otherwise noted}.$  Negative battery current indicates charging.)

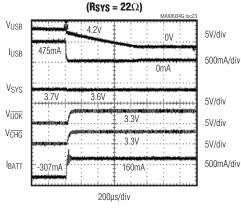
### DC DISCONNECT WITH NO USB



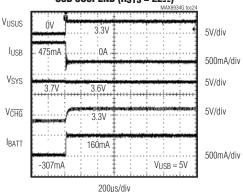
## USB CONNECT WITH NO DC (Rsys = $22\Omega$ )



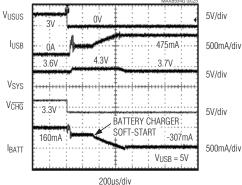
### USB DISCONNECT WITH NO DC



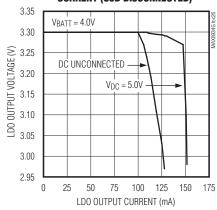
#### USB SUSPEND (Rsys = $22\Omega$ )



### USB RESUME (R<sub>SYS</sub> = $22\Omega$ )

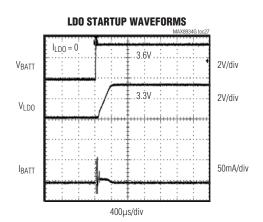


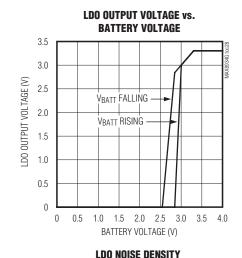
#### LDO OUTPUT VOLTAGE vs. LDO OUTPUT CURRENT (USB DISCONNECTED)

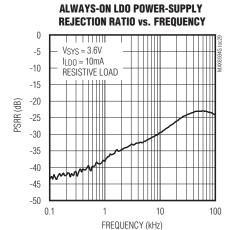


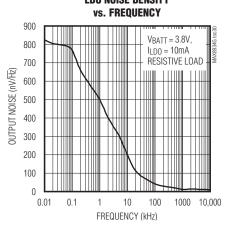
### Typical Operating Characteristics (continued)

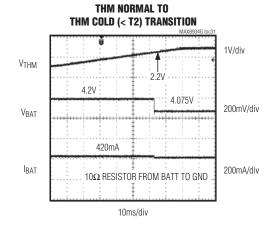
(T<sub>A</sub> = +25°C, circuit of Figure 2, V<sub>DC</sub> = 6V, V<sub>BATT</sub> = 3.6V, thermistor Beta = 3964, unless otherwise noted. Negative battery current indicates charging.)







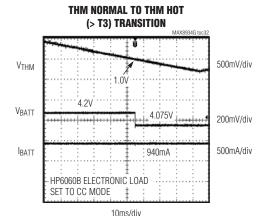


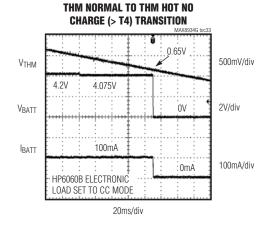


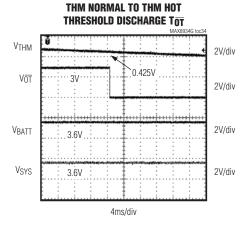
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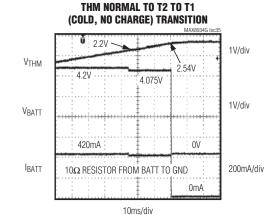
### **Typical Operating Characteristics (continued)**

(T<sub>A</sub> = +25°C, circuit of Figure 2, V<sub>DC</sub> = 6V, V<sub>BATT</sub> = 3.6V, thermistor Beta = 3964, unless otherwise noted. Negative battery current indicates charging.)









### **Pin Description**

PIN	NAME	FUNCTION				
1	DONE	Charge Complete Output. The DONE active-low, open-drain output pulls low when the charger enters the DONE state. The charger current = 0mA when DONE is low. See Figure 7.				
2, 3	DC	DC Power Input. DC is capable of delivering up to 2A to SYS. DC supports both AC adapter and USB inputs. The DC current limit is set with PEN1, PEN2, and RPSET. See Table 2. Both DC pins must be connected together externally. Connect a 10µF ceramic capacitor from DC to GND. The DC inputs should be grounded if not used.				
4	CEN	Active-Low Charger Enable Input. Connect $\overline{\text{CEN}}$ to GND or drive low with a logic signal to enable battery charging when a valid source is connected at DC or USB. Drive high with a logic signal to disable battery charging.				
5	PEN1	Input Limit Control 1. See Table 2 for complete information.				
6	PEN2	Input Limit Control 2. See Table 2 for complete information.				
7	PSET	DC Input Current-Limit Setting. Connect a resistor from PSET to GND to program the DC current limit up to 2A (3000V/RPSET).				
8	VL	Internal Logic LDO Output Bypass Pin. Provides 3.3V when DC or USB is present. Connect a 0.1µF ceramic capacitor from V <sub>L</sub> to GND. V <sub>L</sub> powers the internal circuitry and provides up to 5mA to an external load.				
9, 13	GND	Ground. Both GND pins must be connected together externally.				
10	СТ	Charge Timer Program Input. A capacitor from CT to GND sets the maximum prequal and fast-charge timers. Connect CT to GND to disable the timer.				
11	ISET	Charge Current-Limit Setting. A resistor (R <sub>ISET</sub> ) from ISET to GND programs the fast-charge charge current up to 1.5A (3000V/R <sub>ISET</sub> ). The prequal charge current is 20% of the set fast-charge charge current.				
12	USUS	USB Suspend Digital Input. As shown in Table 2, driving USUS high suspends the DC or USB inputs if they are configured as a USB power input.				
14	THM	Thermistor Input. Connect a negative temperature coefficient (NTC) thermistor with good thermal contact with the battery from THM to GND. Use a thermistor with Beta = 3964. Connect a resistor of equal resistance to the thermistor resistance at +25°C from THM to THMSW so that the battery temperature can be monitored, and the fast-charge current and/or the charge termination voltage is automatically adjusted, in accordance with safety region 2 of the JEITA specification.				
15	THMEN	Thermistor Enable Input. THMEN controls THMSW by connecting the external thermistor pullup res and the thermistor monitoring circuit to LDO. Drive THMEN high to enable the thermistor circuit in				
16	THMSW	Thermistor Pullup Supply Switch. Drive THMEN high to enable the THMSW, shorting the THMSW ou to LDO. Drive THMEN low to open the THMSW switch. THMSW is always on when a valid input sour is present and the battery is being charged. When no input source is present, THMSW is controlled THMEN. THMSW is also active when the battery is being discharged, so that the battery temperatur can be monitored for an overtemperature condition.				

### Pin Description (continued)

PIN	NAME	FUNCTION
17	LDO	Always-On Linear Regulator Output. LDO is the output of an internal always-on 3.3V LDO that provides power to external circuitry. The LDO output provides up to 30mA of current for indicator LEDs or other loads. LDO remains active even when only a battery is present, so that the thermistor monitor circuitry can be activated when the battery is being discharged, and other circuitry can remain powered. Connect a 1µF ceramic capacitor from LDO to GND.
18, 19	USB	USB Power Input. USB is capable of delivering up to 0.5A to SYS. The USB current limit is set with PEN2 and USUS. See Table 2. Both USB pins must be connected together externally. Connect a 4.7µF ceramic capacitor from USB to GND.
20, 21	BATT	Battery Connection. Connect the positive terminal of a single-cell Li+ battery to BATT. The battery charges from SYS when a valid source is present at DC or USB. BATT powers SYS when neither DC nor USB power is present, or when the SYS load exceeds the input current limit. Both BATT pins must be connected together externally.
22	CHG	Charger Status Output. The CHG active-low, open-drain output pulls low when the battery is in fast charge or prequal. Otherwise, CHG is high impedance.
23, 24	SYS	System Supply Output. SYS is connected to BATT through an internal 40mΩ system load switch when DC or USB are invalid, or when the SYS load is greater than the input current limit. When a valid voltage is present at DC or USB, SYS is limited to or 4.35V. When the system load (Isys) exceeds the DC or USB current limit, SYS is regulated to 75mV below VBATT and both the input and the battery service the SYS load. Bypass SYS to GND with a 10μF ceramic capacitor. Both SYS pins must be connected together externally.
25	ŌT	Battery Overtemperature Flag. The $\overline{\text{OT}}$ active-low, open-drain output pulls low when THMEN is high and the battery temperature is $\geq$ +75°C.
26	DOK	DC Power-OK Output. The $\overline{\text{DOK}}$ active-low, open-drain output pulls low when a valid input is detected at DC.
27	UOK	USB Power-OK Output. The UOK active-low, open-drain output pulls low when a valid input is detected at USB.
28	FLT	Fault Output. The FLT active-low, open-drain output pulls low when the battery timer expires before prequal or fast charge complete.
_	EP	Exposed Pad. Connect the exposed pad to GND. Connecting the exposed pad does not remove the requirement for proper ground connections to the appropriate pins.

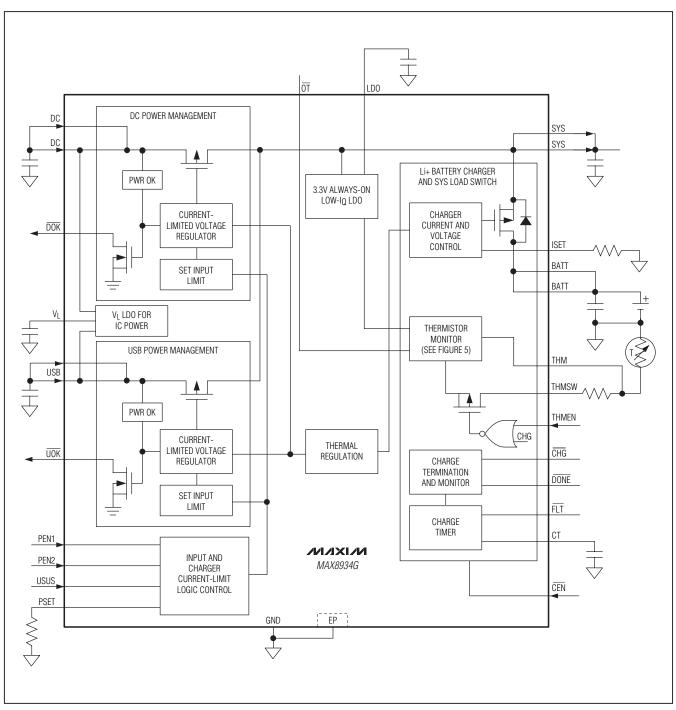


Figure 1. Block Diagram

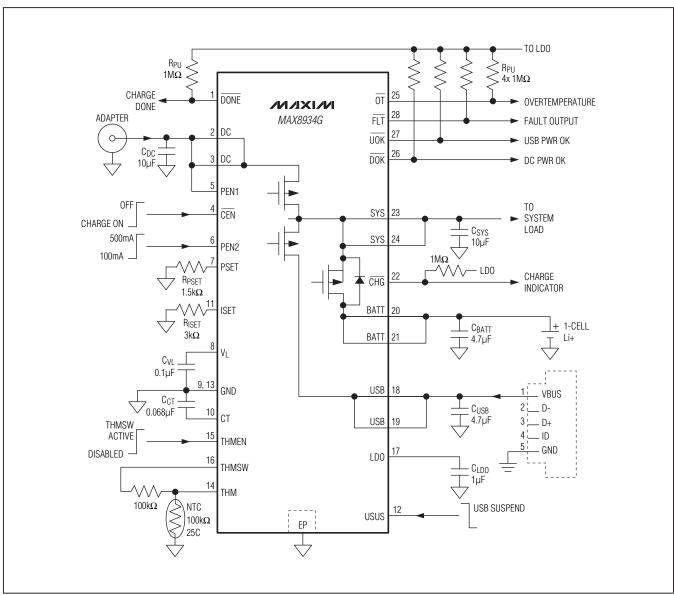


Figure 2. Typical Application Circuit Using Separate DC and USB Connector

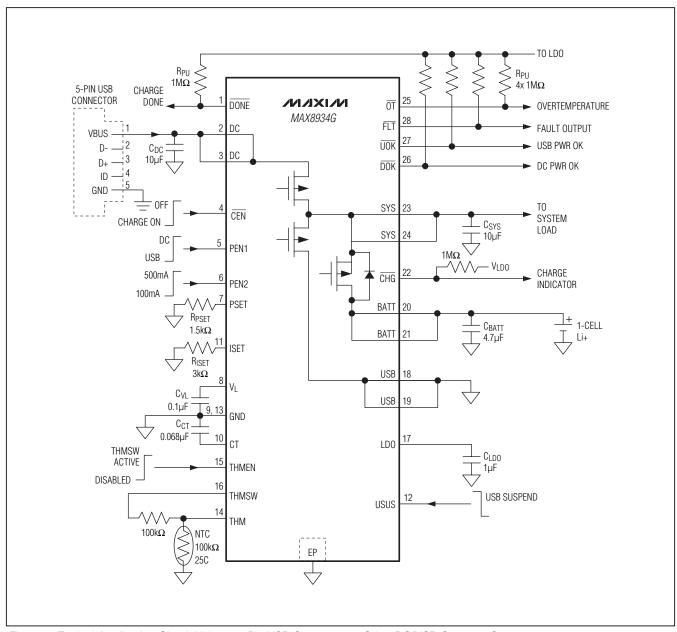


Figure 3. Typical Application Circuit Using a 5-Pin USB Connector or Other DC/USB Common Connector

Table 1. External Components List for Figures 2 and 3

COMPONENT (Figures 2 and 3)	FUNCTION	PART NUMBER
C <sub>DC</sub>	DC filter capacitor	10μF ±10%, 16V X5R ceramic capacitor (0805) Taiyo Yuden EMK212BJ106KG
Cusb	USB filter capacitor	4.7μF ±10%, 10V X5R ceramic capacitor (0805) Taiyo Yuden LMK212BJ475KD
CVL	V <sub>L</sub> filter capacitor	0.1µF ±10%, 10V X5R ceramic capacitor (0402) Taiyo Yuden LMK105BJ104KV
Csys	SYS output bypass capacitors	10μF ±10%, 6.3V X5R ceramic capacitor (0805) Taiyo Yuden JMK212BJ106KD
Сватт	Battery bypass capacitor	4.7μF ±10%, 6.3V X5R ceramic capacitor (0805) Taiyo Yuden JMK212BJ475KD
Сст	Charger timing capacitor	0.068µF ±10%, 16V X5R ceramic capacitor (0402) Taiyo Yuden EMK105BJ683KV
C <sub>LDO</sub>	LDO output capacitor	1μF ±10%, 6.3V X5R ceramic capacitor (0402) Taiyo Yuden JMK105BJ105KV
R <sub>PU</sub> (x5)	Logic-output pullup resistors	1MΩ ±5% resistor
THM	Negative TC thermistor	Vishay NTC Thermistor P/N NTHS0603N01N1003FF
RTHMSW	THM pullup resistor	100kΩ
RPSET	DC input current-limit programming resistor	1.5kΩ ±1% for 2A limit
RISET	Fast-charge current programming resistor	$3k\Omega \pm 1\%$ for 1A charging

### Detailed Description

The MAX8934G is a dual-input linear charger with Smart Power Selector that safely charges a single Li+/Li-Poly cell in accordance with JEITA specifications. The MAX8934G integrates power MOSFETs and control circuitry to manage power flow in portable devices. See Figure 1. The charger has two power inputs, DC and USB. These can be separately connected to an AC adapter output and a USB port, or the DC input could be a single power input that connects to either an adapter or USB. Logic inputs, PEN1 and PEN2, select the correct current limits for two-input or single-input operation. Figure 2 is the typical application circuit using separate DC and USB connectors. Figure 3 is the typical application circuit using a 5-pin USB connector or another DC/USB common connector.

In addition to charging the battery, the MAX8934G also supplies power to the system through the SYS output. The charging current is also provided from SYS so that the set input current limit controls the total SYS current, where total SYS current is the sum of the system load current and the battery-charging current. SYS is powered from either the DC input pin or the USB input pin. If both the DC and USB sources are connected, DC takes precedence.

In some instances, there may not be enough adapter current or USB current to supply peak system loads. The MAX8934G Smart Power Selector circuitry offers flexible power distribution from an AC adapter or USB source to the battery and system load. The battery is charged with any available power not used by the system load. If a system load peak exceeds the input current limit, supplemental current is taken from the battery. Thermal limiting prevents overheating by reducing power drawn from the input source.

The MAX8934G features an overvoltage limiter at SYS. If the DC or USB input voltage exceeds the SYS regulation voltage, Vsys does not follow VDC or VUSB, but remains at its regulation voltage. The MAX8934G has numerous other charging and power-management features that are detailed in the following sections.

A 3.3V ultra-low quiescent current, always-on LDO provides up to 30mA for indicator LEDs and for backup power to the system. This LDO powers the thermistor monitor circuitry and provides bias to the external pullup resistor for the thermistor.

#### **Smart Power Selector**

The MAX8934G Smart Power Selector seamlessly distributes power among the external inputs, the battery, and the system load (see the *Typical Operating Circuit*). The basic functions performed are:

- With both an external power supply (USB or adapter) and battery connected:
  - When the system load requirements are less than the input current limit, the battery is charged with residual power from the input.
  - When the system load requirements exceed the input current limit, the battery supplies supplemental current to the load.
- When the battery is connected and there is no external power input, the system is powered from the battery.
- When an external power input is connected and there is no battery, the system is powered from the external power input.

#### System Load Switch

An internal 40m $\Omega$  MOSFET connects SYS to BATT (Q3 in the *Typical Operating Circuit*) when no voltage source is available at DC or USB. When an external source is detected at DC or USB, this switch is opened and SYS is powered from the valid input source through the input limiter.

The SYS-BATT switch also holds up SYS when the system load exceeds the input current limit. If that should happen, the SYS-BATT switch turns on so that the battery supplies additional SYS load current. If the system load continuously exceeds the input current limit, the battery does not charge, even though external power is connected. This is not expected to occur in most cases, since high loads usually occur only in short peaks. During these peaks, battery energy is used, but at all other times the battery charges.

#### **Input Limiter**

The input voltage limiter is essentially an LDO regulator. While in dropout, the regulator dissipates a small I²R loss through the 0.2 $\Omega$  MOSFET (Q1 in the *Typical Operating Circuit*) between DC and SYS. With an AC adapter or USB source connected, the input limiter distributes power from the external power source to the system load and battery charger. In addition to the input limiter's primary function of passing power to the system and charger loads at SYS, it performs several additional functions to optimize use of available power.

#### Input Voltage Limiting

If an input voltage is above the overvoltage threshold (6.9V typ), the MAX8934G enters overvoltage lockout (OVLO). OVLO protects the MAX8934G and downstream circuitry from high-voltage stress up to 14V at DC and 8V at USB. In OVLO, VL remains on, the input switch that sees overvoltage (Q1, Q2, Typical Operating Circuit) opens, the appropriate power-monitor output (DOK, UOK) is high impedance, and CHG is high impedance. If both DC and USB see overvoltage, both input switches (Q1 and Q2, Typical Operating Circuit) open and the charger turns off. The BATT-to-SYS switch (Q3, Typical Operating Circuit) closes, allowing the battery to power SYS. An input is also invalid if it is less than BATT, or less than the DC undervoltage threshold of 3.5V (falling). With an invalid input voltage, SYS connects to BATT through a 40mΩ switch (Q3, Typical Operating Circuit).

#### Input Overcurrent Protection

The current at DC and USB is limited to prevent input overload. This current limit can be selected to match the capabilities of the source, whether it is a 100mA or 500mA USB source, or an AC adapter. When the load exceeds the input current limit, SYS drops to 75mV below BATT and the battery supplies supplemental load current.

#### Thermal Limiting

The MAX8934G reduces input limiter current by 5%/°C when its die temperature exceeds +100°C. The system load (SYS) has priority over the charger current, so lowering the charge current first reduces the input current. If the junction temperature still reaches +120°C in spite of charge current reduction, no input (DC or USB) current is drawn, the battery supplies the entire system load, and SYS is regulated at 75mV below BATT. Note that this on-chip thermal-limiting circuitry is not related to and operates independently from the thermistor input.

#### Adaptive Battery Charging

While the system is powered from DC, the charger draws power from SYS to charge the battery. If the charger load plus system load exceeds the input current limit, an adaptive charger control loop reduces charge current to prevent the SYS voltage from collapsing. Maintaining a higher SYS voltage improves efficiency and reduces power dissipation in the input limiter. The total current through the switch (Q1 or Q2 in the *Typical Operating Circuit*) is the sum of the load current at SYS and the battery charging current. The MAX8934G limiter clamps at 4.35V, so input voltages greater than 4.35V can increase power dissipation in the limiter. The MAX8934G input

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limiter power loss is (VDC – VSYS) x IDC, where VSYS may be as high as 4.35V. The input limiter power loss is not less than  $0.2\Omega$  x IDC<sup>2</sup>. Also note that the MAX8934G turns off when any input exceeds 6.9V (typ).

## DC and USB Connections and Current-Limit Options

#### Input Current Limit

The input and charger current limits are set as shown in Table 2. It is often preferable to change the input current limit as the input power source is changed. The MAX8934G facilitates this by allowing different input current limits for DC and USB as shown in Table 2.

When the input current limit is reached, the first action taken by the MAX8934G is to reduce the battery charge current. This allows the regulator to stay in dropout during heavy loads, thus reducing power dissipation. If, after the charge current is reduced to 0mA, the load at SYS still exceeds the input current limit. SYS voltage begins to fall. When the SYS voltage drops to BATT, the SYSto-BATT switch turns on, using battery power to support the system load during the load peak. The MAX8934G features flexible input connections (at the DC and USB input pins) and current-limit settings (set by PEN1, PEN2, PSET, and ISET) to accommodate nearly any input power configuration. However, it is expected that most systems use one of two external power schemes: separate connections for USB and an AC adapter, or a single connector that accepts either USB or AC adapter output. Input and charger current limit are controlled by PEN1, PEN2, RPSFT, and RISFT, as shown in Table 2.

### **Separate Adapter and USB Connectors**

When the AC adapter and USB have separate connectors, the adapter output connects to DC and the USB source connects to USB. PEN1 is permanently connected high (to DC or VL). The DC current limit is set by RPSET, while the USB current limit is set by PEN2 and USUS.

## Single Common Connector for USB or Adapter

When a single common connector is used for both AC adapter and USB sources, the DC input is used for both input sources. The unused USB inputs should be grounded when an AC adapter is connected at DC, PEN1 should be pulled high to select the current limit set by RPSET. When a USB source is connected, PEN1 should be low to select 500mA, 100mA, or USB suspend (further selected by PEN2 and USUS). PEN1 can be pulled up by the AC adapter power to implement hardware adapter/USB selection.

#### **USB Suspend**

Driving USUS high when PEN1 is low turns off the charger and reduces input current to 190µA to accommodate USB suspend mode. The input limiter is disabled and SYS is supported by BATT.

#### Power Monitor Outputs (UOK, DOK)

DOK is an open-drain output that pulls low when the DC input has valid power. UOK is an open-drain output that pulls low when the USB input has valid power. A valid input for DC or USB is between 4.1V and 6.6V. If a single power-OK output is preferred, DOK and UOK can be wire-ORed together. The combined output then pulls low if either USB or DC is valid.

Table 2. Input Limiter Control Logic

POWER SOURCE	DOK	UOK	PEN1	PEN2	usus	DC INPUT CURRENT LIMIT	USB INPUT CURRENT LIMIT	MAXIMUM CHARGE CURRENT*
AC adapter at DC input	L	Х	Н	X	×	3000V/R <sub>PSET</sub>	USB input off;	3000V/RISET
1100	L	Х	L	Н	L	475mA	DC input has	475mA
USB power at DC input	L	Х	L	L	L	95mA	priority	95mA
DO Input	L	Χ	L	X	Н	USB suspend		0
USB power at	Н	L	X	Н	L		475mA	2000\//Dia==
USB input; DC	Н	L	X	L	L		95mA	3000V/RISET
unconnected	Н	L	X	X	Н	No DC input	USB suspend	0
DC and USB unconnected	Н	Н	Х	Х	Х		No USB input	0

<sup>\*</sup>Charge current cannot exceed the input current limit. Actual charge current may be less than the maximum charge current if the total SYS load exceeds the input current limit.



#### Soft-Start

To prevent input transients that can cause instability in the USB or AC adapter power source, the rate of change of input current and charge current is limited. When a valid DC or USB input is connected, the input current limit is ramped from zero to the set current-limit value (as shown in Table 2). If DC is connected with no USB power present, input current ramps in 1.5ms. If DC is connected with USB already present, input current ramps in 50µs. When USB is connected with no DC present, input current also ramps in 50µs. If USB is connected with DC already present, the USB input is ignored.

If an adapter is plugged into DC while USB is already powered, the input current limit reramps from zero back up to the DC current limit so that the AC adapter does not see a load step. During this transition, if the input current limit is below the SYS load current, the battery supplies the additional current needed to support the load. Additionally, capacitance can be added to SYS to support the load during input power transitions. When the charger is turned on, charge current ramps from zero to the ISET current value in 1.5ms. Charge current also ramps when transitioning to fast-charge from prequal and when changing the USB charge current from 100mA to 500mA with PEN2. There is no dl/dt limiting, however, if ISET is changed suddenly using a switch at RISET.

#### **Battery Charger**

The battery charger state diagram is illustrated in Figure 7. With a valid DC or USB input, the battery charger initiates a charge cycle when the charger is enabled. It first detects the battery voltage. If the battery voltage is less than the BATT pregual threshold (3.0V), the charger enters pregual mode and charges the battery at 20% of the maximum fast-charge current. This reduced charge rate ensures that the maximum fast-charge current setting does not damage a deeply discharged battery. Once the battery voltage rises to 3.0V, the charger transitions to fast-charge mode and applies the maximum charge current. As charging continues, the battery voltage rises until it approaches the battery regulation voltage where charge current starts tapering down. When charge current decreases to 20% of the fast-charge current, the charger enters a brief 15s top-off state, then DONE pulls low and charging stops. If the battery voltage subsequently drops below the recharge threshold, charging restarts and the timers reset.

#### Charge Enable (CEN)

When  $\overline{\text{CEN}}$  is low, the charger is on. When  $\overline{\text{CEN}}$  is high, the charger turns off.  $\overline{\text{CEN}}$  does not affect the SYS output. In many systems, there is no need for the system controller (typically a microprocessor) to disable the charger, because the MAX8934G Smart Power Selector circuitry independently manages charging and adapter/battery power hand-off. In these situations,  $\overline{\text{CEN}}$  can be connected to ground.

#### **Setting the Charge Current**

ISET adjusts charge current to match the capacity of the battery. A resistor from ISET to ground sets the maximum fast-charge current:

ICHGMAX = 2000 x 1.5V/RISET = 3000V/RISET

Determine the ICHGMAX value by considering the characteristics of the battery. It is not necessary to limit the charge current based on the capabilities of the expected AC adapter/USB charging input, the system load, or thermal limitations of the PCB. The MAX8934G automatically adjusts the charging algorithm to accommodate these factors.

#### **Monitoring the Charge Current**

In addition to setting the charge current, ISET can also be used to monitor the actual current charging the battery. See Figure 4. The ISET output voltage is:

VISET = ICHG x 1.5V/ICHGMAX = ICHG x RISET/2000

where ICHGMAX is the set fast-charge current and ICHG is the actual battery charge current. A 1.5V output indicates the battery is being charged at the maximum set fast charge current; 0V indicates no charging. This voltage is also used by the charger control circuitry to set and monitor the battery current. Avoid adding more than 10pF capacitance directly to the ISET pin. If filtering of the charge-current monitor is necessary, add a resistor of 100k $\Omega$  or more between ISET and the filter capacitor to preserve charger stability.

Note that the actual charge current can be less than the set fast-charge current when the charger enters voltage mode or when the input current limiter or thermal limiter reduces charge current. This prevents the charger from overloading the input source or overheating the system.

#### **Charge Termination**

When the charge current falls to the termination threshold and the charger is in voltage mode, charging is complete. Charging continues for a brief 15s top-off period and then enters the DONE state where charging stops. The DONE current threshold (IDONE) is set to 20% of the

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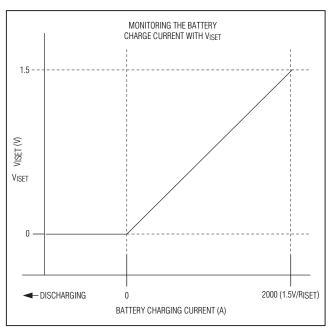


Figure 4. Monitoring the Battery Charge Current with VISET

fast-charge current setting. Note that if charge current falls to IDONE as a result of the input or thermal limiter, the charger does not enter the DONE state. For the charger to enter the DONE state, the charge current must be less than IDONE, the charger must be in voltage mode, and the input or thermal limiter must not be reducing the charge current. The charger exits the DONE state, and fast-charge resumes if the battery voltage subsequently drops 104mV or if  $\overline{\text{CEN}}$  is cycled.

## Charge Status Outputs Charge Output (CHG)

CHG is an open-drain, active-low output that is low during charging. CHG is low when the battery charger is in its prequalification and fast-charge states. When charge current falls to the charge termination threshold (IDONE) and the charger is in voltage mode, CHG goes high impedance. CHG goes high impedance if the thermistor causes the charger to enter temperature suspend mode.

When the MAX8934G is used with a microprocessor ( $\mu P$ ), connect a pullup resistor between  $\overline{CHG}$  and the logic I/O voltage to indicate charge status to the  $\mu P$ . Alternatively,  $\overline{CHG}$  can sink up to 20mA for an LED indicator.

#### Charge DONE Output (DONE)

DONE is an open-drain, active-low output that goes low when charging is complete. The charger enters its DONE state 15s after the charge current falls to the

charge-termination threshold (IDONE) and the charger is in voltage mode. The charger exits the DONE state, and fast-charge resumes, if the battery voltage subsequently drops 104mV, or if input power or  $\overline{\text{CEN}}$  is cycled. When the MAX8934G is used in conjunction with a  $\mu\text{P}$ , connect a pullup resistor between  $\overline{\text{DONE}}$  and the logic I/O voltage to indicate charge status to the  $\mu\text{P}$ . Alternatively,  $\overline{\text{DONE}}$  can sink up to 20mA for an LED indicator.

#### Fault Output (FLT) and Charge Timer

FLT is an open-drain, active-low output that goes low during a battery fault. The fault state occurs when either the prequal or fast-charge timer expires. The prequal and fast-charge fault timers are set by CCT:

PREQUAL: 
$$t_{PQ} = 180 \text{min} \times \frac{C_{CT}}{0.068 \mu F}$$

FAST CHARGE: 
$$t_{FC} = 300 \text{min} \times \frac{C_{CT}}{0.068 \mu F}$$

$$TOP-OFF:t_{TO} = 15s$$

While in fast-charge mode, a large system load or device self-heating can cause the MAX8934G to reduce charge current. Under these circumstances, the fast-charge timer adjusts to ensure that adequate charge time is still allowed. Consequently, the fast-charge timer is slowed by 2x if charge current is reduced below 50% of the programmed fast-charge level. If charge current is reduced to below 20% of the programmed level, the fast-charge timer is paused. The fast-charge timer is not adjusted if the charger is in voltage mode where charge current reduces due to current tapering under normal charging.

To exit a fault state, toggle  $\overline{\text{CEN}}$  or remove and reconnect the input source(s). Note also that thermistor out of range or on-chip thermal-limit conditions are not considered faults. When the MAX8934G is used in conjunction with a  $\mu\text{P}$ , connect a pullup resistor between  $\overline{\text{FLT}}$  and the logic I/O voltage to indicate fault status to the  $\mu\text{P}$ . Alternatively,  $\overline{\text{FLT}}$  can sink up to 20mA for an LED indicator.

#### **Thermistor Monitor**

The MAX8934G thermistor monitor is configured to execute JEITA recommendations regarding Li+/Li-Poly battery charging by adjusting the fast charge current and/or the charge termination voltage accordingly (see Figure 6 ). Connect the THM input to an external negative temperature coefficient (NTC) thermistor to monitor battery or system temperature. Since the thermistor monitoring circuit employs an external bias resistor from THM to THMSW, the thermistor is not limited only to  $10k\Omega$  (at

+25°C). Any thermistor resistance can be used as long as the value of RTHMSW is equivalent to the thermistor's +25°C resistance. The MAX8934G THM thresholds are optimized for a thermistor Beta of 3964. The general relation of thermistor resistance to temperature is defined by the following equation:

$$R_T = R_{25} \times e^{\left\{\beta \left(\frac{1}{T + 273^{\circ}C} - \frac{1}{298^{\circ}C}\right)\right\}}$$

where:

 $R_T$  = The resistance in ohms of the thermistor at temperature T in  ${}^{\circ}C$ 

 $R_{25}$  = The resistance in ohms of the thermistor at  $+25^{\circ}C$ 

 $\beta$  = The material constant of the thermistor

T = The temperature of the thermistor in °C

Charging is suspended when the thermistor temperature is out of range (VTHM\_T1 < VTHM or VTHM < VTHM\_T4). The charge timers are also suspended and hold their state but no fault is indicated. When the thermistor comes back into range, charging resumes and the charge timer continues from where it left off.

The THMEN input controls THMSW and the thermistor monitor circuitry when the battery charger is disabled, providing the user with the means to minimize the battery current drain caused by the thermistor monitor. The THMEN input is ignored while the battery is charging, since the thermistor must be monitored at all times.

While charging, the thermistor monitor is used to automatically adjust the charge termination voltage and/or

the fast-charge current, depending on the sensed battery temperature. If the battery temperature exceeds the THM hot overtemperature threshold and THMEN is high, the  $\overline{OT}$  flag pulls low. Typical systems connect  $\overline{OT}$  to a  $\mu P$  input so that the system can safely shut down.

#### Always-On LDO

The ultra-low quiescent current LDO is always on and is preset to an output voltage of 3.3V. The LDO provides up to 30mA output current. When DC and USB are invalid and the battery is discharging, the LDO output voltage tracks VSYS as it drops below 3.3V. A 1 $\mu$ F ceramic capacitor connected from LDO to GND is recommended for most applications.

### Power Dissipation PCB Layout and Routing

Good design minimizes ground bounce and voltage gradients in the ground plane. GND should connect to the power-ground plane at only one point to minimize the effects of power-ground currents. Battery ground should connect directly to the power-ground plane. Connect GND to the exposed pad directly under the IC. Use multiple tightly spaced vias to the ground plane under the exposed pad to help cool the IC. Position input capacitors from DC, SYS, BATT, and USB to the power-ground plane as close as possible to the IC. Keep high current traces such as those to DC, SYS, and BATT as short and wide as possible. Refer to the MAX8934A Evaluation Kit for a suitable PCB layout example.

**Table 3. Package Thermal Characteristics** 

	28-PIN 4	28-PIN 4mm x 4mm THIN QFN					
	SINGLE-LAYER PCB	MULTILAYER PCB					
Continuous Power Dissipation	1666.7mW (derate 20.8mW/°C above +70°C)	2285.7mW (derate 28.6mW/°C above +70°C)					
θЈА	48°C/W	35°C/W					
θJC	3°C/W	3°C/W					

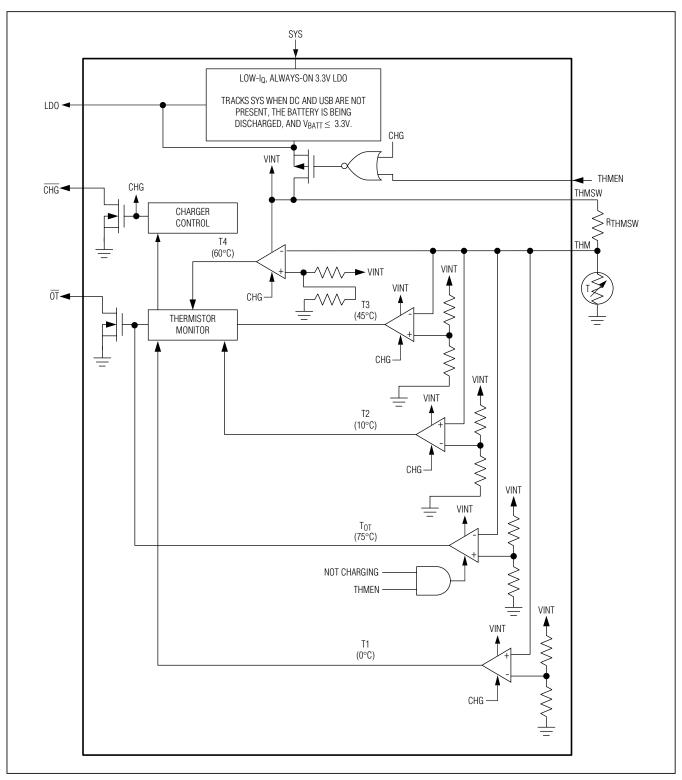


Figure 5. Thermistor Monitor Details

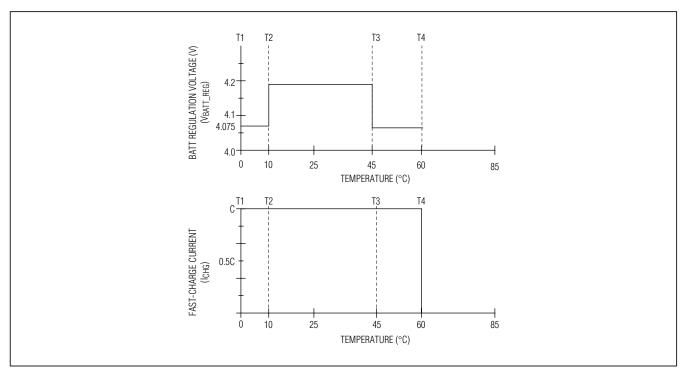


Figure 6. Safety Region 2: Fast-Charge Currents and Charge Termination Voltages

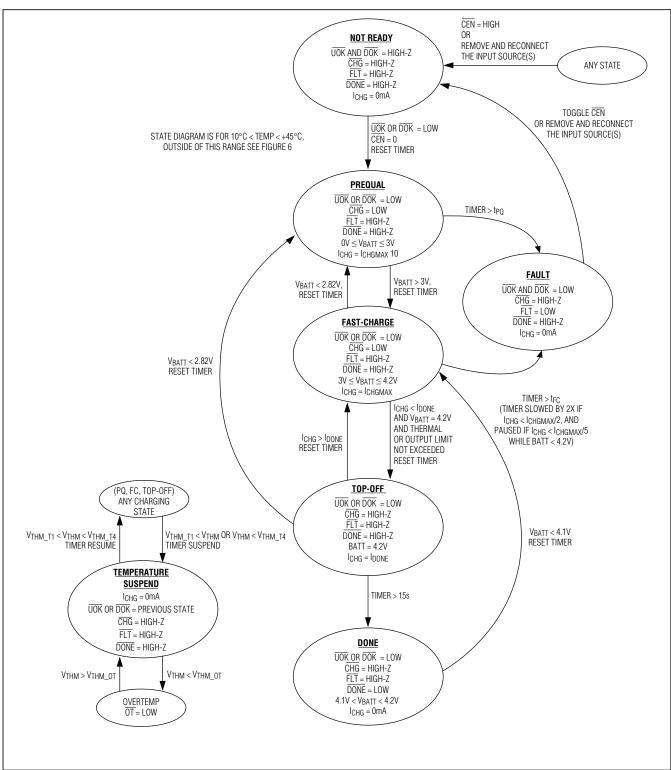
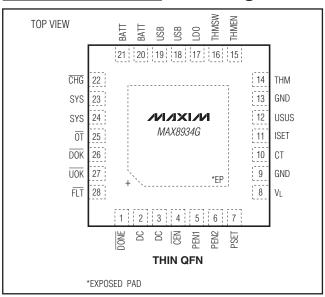


Figure 7. Charger State Diagram

**Chip Information** 

PROCESS: BiCMOS

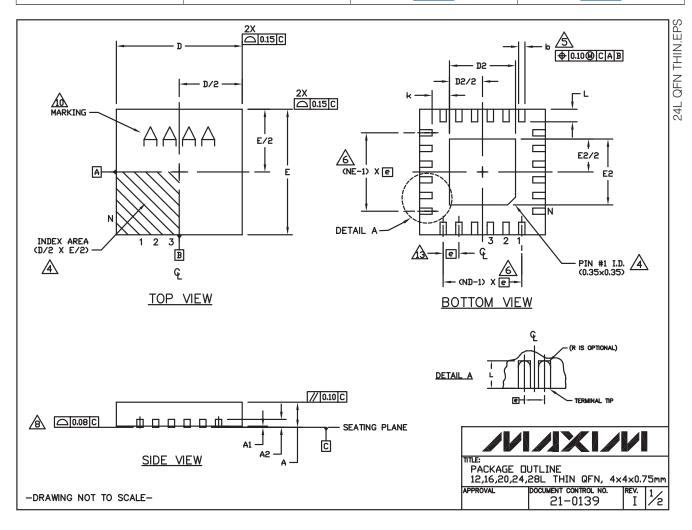
### **Pin Configuration**



#### Package Information

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE		PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.		
	28 TQFN-EP	T2844+1	21-0139	90-0068		



### **Package Information (continued)**

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

	COMMON DIMENSIONS														
PKG	PKG 12L 4x4		16L 4×4		20L 4×4			24L 4×4			28L 4×4				
REF.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05	0.0	0.02	0.05
A2 0.2		.20 RE	F	0.20 REF		F	0.20 REF			0.20 REF			0.20 REF		
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.18	0.23	0.30	0.15	0.20	0.25
D	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
E	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10	3.90	4.00	4.10
e	e 0.80 BSC.		0.65 BSC.		0.50 BSC.		0.50 BSC.			0.40 BSC.					
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-
L	0.45	0.55	0.65	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N	N 12		16		20		24			28					
ND	3		4		5		6			7					
NE	NE 3		4		5		6			7					
Jedec	Jedec WGGB		WGGC		WGGD-1		WGGD-2			WGGE					

EXPOSED PAD VARIATIONS							
PKG. CODES		D2		E2			
	MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	
T1244-3	1.95	2.10	2.25	1.95	2.10	2.25	
T1244-4	1.95	2.10	2.25	1.95	2.10	2.25	
T1644-3	1.95	2.10	2.25	1.95	2.10	2.25	
T1644-4	1.95	2.10	2.25	1.95	2.10	2.25	
T2044-2	1.95	2.10	2.25	1.95	2.10	2.25	
T2044-3	1.95	2.10	2.25	1.95	2.10	2.25	
T2444-2	1.95	2.10	2.25	1.95	2.10	2.25	
T2444-3	2.45	2.60	2.63	2.45	2.60	2.63	
T2444-4	2.45	2.60	2.63	2.45	2.60	2.63	
T2444N-4	2.45	2.60	2.63	2.45	2.60	2.63	
T2444M-1	2.45	2.60	2.63	2.45	2.60	2.63	
T2844-1	2.50	2.60	2.70	2.50	2.60	2.70	

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS, ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.
- ⚠ THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP.

  ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- & COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR T2444-3, T2444-4 AND T2844-1.

  1. MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.
- 11. COPLANARITY SHALL NOT EXCEED 0.08mm.
- 12. WARPAGE SHALL NOT EXCEED 0.10mm.
- ⚠ LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.
- 14. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- 15. ALL DIMENSIONS ARE THE SAME FOR LEADED (-) & POFREE (+) PACKAGE CODES.

PACKAGE DUTLINE 12,16,20,24,28L THIN QFN, 4×4×0.75mm DOCUMENT CONTROL NO. 21-0139

-DRAWING NOT TO SCALE-

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION DATE	
0	6/10	Initial release	_

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